

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Receipt
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Patent application of:

Hiroto OHTAKE et al

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Appln. No.:

10/080,848

Art Unit: 2814

Filed:

February 22, 2002

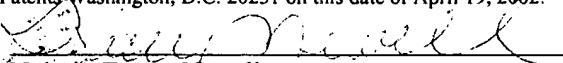
Examiner: To be Assigned

For: **METHOD OF MANUFACTURING A
SEMICONDUCTOR DEVICE CAPABLE
OF ETCHING A MULTI-LAYER OF
ORGANIC FILMS AT A HIGH
SELECTIVITY**

Docket No.: KRM-00101

Certificate of Mailing

I hereby certify that the foregoing documents are being deposited with the United States Postal Service as first class mail, in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231 on this date of April 19, 2002.


Name: Tracey Newell

REQUEST FOR CORRECTION OF FILING RECEIPT

Customer Corrections Branch
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Washington, DC 20231

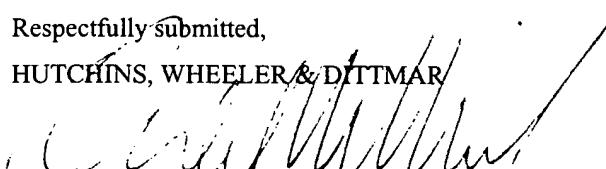
Sir:

Enclosed is a copy of the Filing Receipt for the above-identified U.S. patent application as well as a copy of the originally-filed Declaration. Please correct the number of independent claims to be 9. The change is noted in red on the copy of the Filing Receipt.

Should there be any questions concerning this request, the Examiner is invited to contact the undersigned at (617) 951-6676.

Respectfully submitted,

HUTCHINS, WHEELER & DITTMAR


Donald W. Muirhead
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April 19, 2002

Date

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APPLICATION NUMBER	FILED DATE	GRP ART UNIT	FIL FEE RECD	ATTY.DOCKET.NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
10/080,848	02/22/2002	2814	1490	KRM-00101	25	29	10

CONFIRMATION NO. 9662

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Date Mailed: 04/11/2002

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Applicant(s)

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Assignment For Published Patent Application

NEC Corporation;

Domestic Priority data as claimed by applicant

Foreign Applications

JAPAN 047358/2001 02/22/2001

If Required, Foreign Filing License Granted 03/19/2002

Projected Publication Date: 08/22/2002

Non-Publication Request: No

Early Publication Request: No

Title



Method of manufacturing a semiconductor device capable of etching a multi-layer of organic films at a high selectivity

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Preliminary Class

257

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